CGB
LC75852E
LC75852W

ON Semiconductor®

CMOS LSI

Asynchronous Silicon Gate
1/2 Duty LCD Driver
with On-Chip Key Input Function

Overview

The LC75852E and LC75852W are 1/2 duty dynamic LCD display drivers. In addition to being able to directly drive LCD panels with up to 90 segments, they can also control up to four general-purpose output ports. These products also include a key scan circuit which allows them to accept input from keypads with up to 30 keys. This allows end product front panel wiring to be simplified.

Features

- Up to 30 key inputs (Key scan is only performed when a key is pressed.)
- 1/2 duty – 1/2 bias (up to 90 segments)
- Sleep mode and the all segments off function can be controlled from serial data.
- Segment output port/general-purpose output port usage can be controlled from serial data.
- Serial data I/O supports CCB format communication with the system controller.
- High generality since display data is displayed directly without decoder intervention
- Reset pin that can establish the initial state.

Specifications

Absolute Maximum Ratings at Ta = 25°C, $V_{SS} = 0V$

| Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V_{DD} max	V_{DD}	–0.3 to +7.0	V
Input voltage	V_{IN}	OSC, CE, CL, DI, $\overline{RES}$, KI1 to KI5	–0.3 to V_{DD}+0.3	V
Output voltage	V_{OUT}	OSC, DO, S1 to S45, COM1, COM2, KS1 to KS6, P1 to P4	–0.3 to V_{DD}+0.3	V
Output current	$I_{OUT}1$	S1 to S45	100	μA
	$I_{OUT}2$	COM1, COM2, KS1 to KS6	1	mA
	$I_{OUT}3$	P1 to P4	5	
Allowable power dissipation	Pd max	Ta = 85°C	200	mW
Operating temperature	Topr		–40 to +85	°C
Storage temperature	Tstg		–55 to +125	°C

Package Dimensions

unit : mm (typ)

[LC75852E]
QIP64E(14X14)
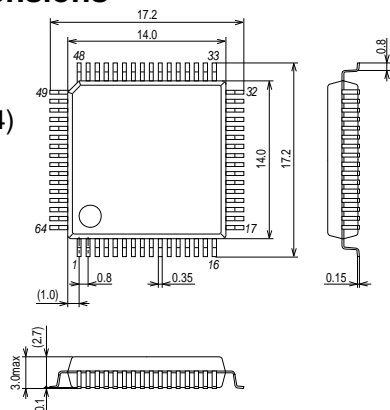
[LC75852W]
SQFP64(10X10)
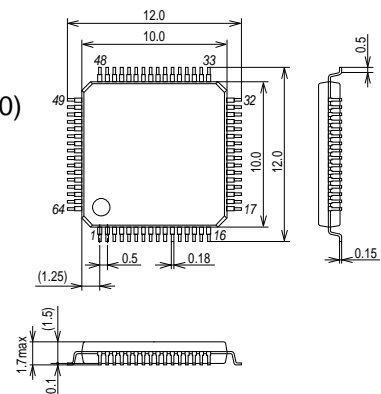
- CCB is ON Semiconductor® 's original format. All addresses are managed by ON Semiconductor® for this format.

- CCB is a registered trademark of Semiconductor Components Industries, LLC.

Allowable Operating Ranges at Ta = –40 to +85°C, V_{SS} = 0 V

| Parameter	Symbol	Conditions	min	typ	max	Unit
Supply voltage	V_{DD}	V_{DD}	4.5		6.0	V
Input high-level voltage	$V_{IH}1$	CE, CL, DI, $\overline{RES}$	0.8 V_{DD}		V_{DD}	V
	$V_{IH}2$	KI1 to KI5	0.6 V_{DD}		V_{DD}	V
Input low-level voltage	V_{IL}	CE, CL, DI, $\overline{RES}$, KI1 to KI5	0		0.2 V_{DD}	V
Recommended external resistance	R_{OSC}	OSC		62		kΩ
Recommended external capacitance	C_{OSC}	OSC		680		pF
Guaranteed oscillator range	f_{OSC}	OSC	25	50	100	kHz
Data setup time	t_{ds}	CL, DI: Figure 1	160			ns
Data hold time	t_{dh}	CL, DI: Figure 1	160			ns
CE wait time	t_{cp}	CE, CL: Figure 1	160			ns
CE setup time	t_{cs}	CE, CL: Figure 1	160			ns
CE hold time	t_{ch}	CE, CL: Figure 1	160			ns
High-level clock pulse width	$t_{øH}$	CL: Figure 1	160			ns
Low-level clock pulse width	$t_{øL}$	CL: Figure 1	160			ns
Rise time	t_r	CE, CL, DI: Figure 1		160		ns
Fall time	t_f	CE, CL, DI: Figure 1		160		ns
DO output delay time	t_{dc}	DO, R_{PU} = 4.7 kΩ, C_L = 10 pF*: Figure 1			1.5	µs
DO rise time	t_{dr}	DO, R_{PU} = 4.7 kΩ, C_L = 10 pF*: Figure 1			1.5	µs
$\overline{RES}$ switching time	t2	Figure 2	10			µs

Note: * Since DO is an open-drain output, these values differ depending on the pull-up resistor R_{PU} and the load capacitance C_L.

Electrical Characteristics in the Allowable Operating Ranges

Parameter	Symbol	Conditions	min	typ	max	Unit
Hysteresis	V_H	CE, CL, DI, $\overline{RES}$, KI1 to KI5		0.1 V_{DD}		V
Input high-level current	I_{IH}	CE, CL, DI, $\overline{RES}$: V_I = 6.0 V			5.0	µA
Input low-level current	I_{IL}	CE, CL, DI, $\overline{RES}$: V_I = 0 V	−5.0			µA
Input floating voltage	V_{IF}	KI1 to KI5			0.05 V_{DD}	V
Pull-down resistance	R_{PD}	KI1 to KI5: V_{DD} = 5.0 V	50	100	250	kΩ
Output off leakage current	I_{OFFH}	DO: V_O = 6.0 V			6.0	µA
Output high-level voltage	$V_{OH}1$	KS1 to KS6: I_O = −1 mA	V_{DD} − 1.0			V
	$V_{OH}2$	P1 to P4: I_O = −1 mA	V_{DD} − 1.0			V
	$V_{OH}3$	S1 to S45: I_O = −10 µA	V_{DD} − 1.0			V
	$V_{OH}4$	COM1, COM2: I_O = −100 µA	V_{DD} − 0.6			V
Output low-level voltage	$V_{OL}1$	KS1 to KS6: I_O = 50 µA	0.4	1.0	3.0	V
	$V_{OL}2$	P1 to P4: I_O = 1 mA			1.0	V
	$V_{OL}3$	S1 to S45: I_O = 10 µA			1.0	V
	$V_{OL}4$	COM1, COM2: I_O = 100 µA			0.6	V
	$V_{OL}5$	DO: I_O = 1 mA		0.1	0.5	V
Output middle-level voltage	$V_{MID}1$	COM1, COM2: V_{DD} = 6.0 V, I_O = ±100 µA	2.4	3.0	3.6	V
	$V_{MID}2$	COM1, COM2: V_{DD} = 4.5 V, I_O = ±100 µA	1.65	2.25	2.85	V
Current drain	$I_{DD}1$	Sleep mode, Ta = 25°C			5	µA
	$I_{DD}2$	V_{DD} = 6.0 V, output open, Ta = 25°C, f_{OSC} = 50 kHz		1.4	2.5	mA

1. When stopped with CL at the low level
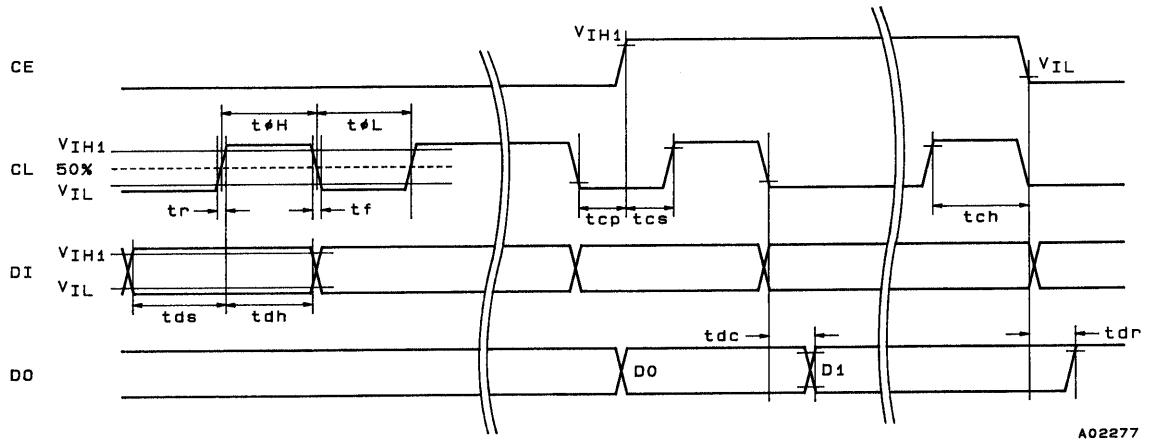
2. When stopped with CL at the high level
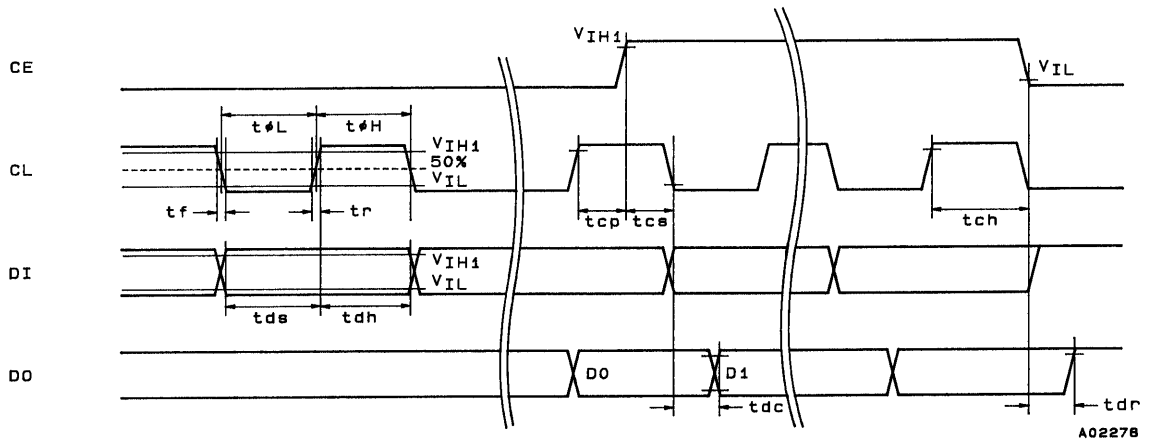
Figure 1

Pin Assignment

Top view

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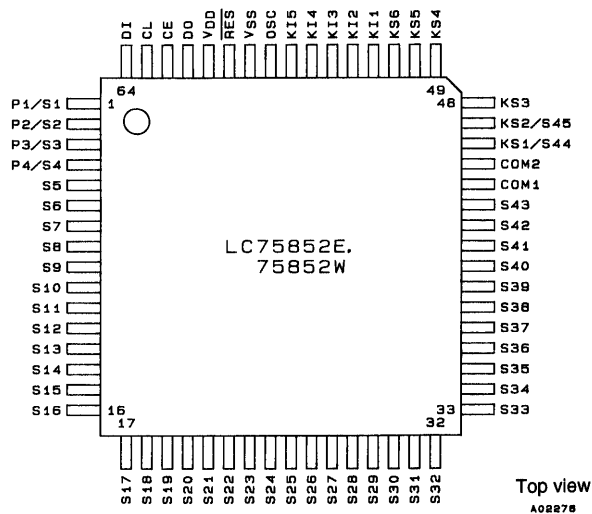
Block Diagram
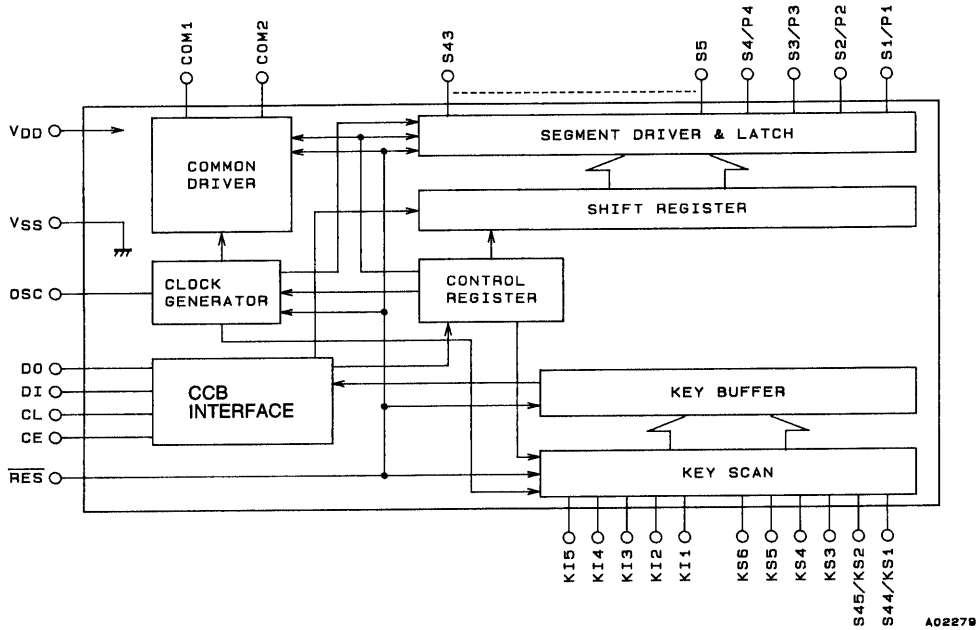
Pin Functions

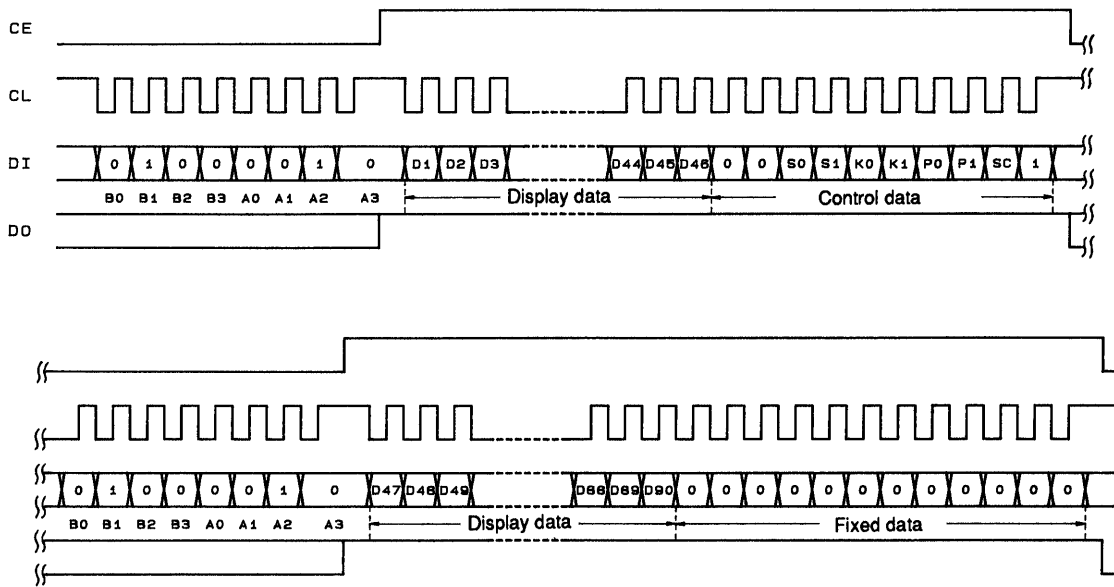| Pin	Pin No.	Function		Active	I/O	Handling when unused
S1/P1 to S4/P4 S5 to S43	1 to 4 5 to 43	Segment outputs: Used to output the display data that is transmitted over the serial data input. Pins S1/P1 to S4/P4 can be used as general-purpose outputs according to control data specification.		—	O	Open
COM1 COM2	44 45	Common driver outputs. The frame frequency f_O is (f_{OSC}/512) Hz.		—	O	Open
KS1/S44, KS2/S45, KS3 to KS6	46 47 48 to 51	Key scan outputs. When a key matrix is formed, normally a diode will be attached to the key scan timing line to prevent shorts. However, since the output transistor impedance is an unbalanced CMOS output, it will not be damaged if shorted. Pins KS1/S44 and KS2/S45 can be used as segment outputs according to control data specification.		—	O	Open
KI1 to KI5	52 to 56	Key scan inputs: Pins with a built-in pull-down resistor.		H	I	GND
OSC	57	Oscillator connection: Oscillator circuit can be formed by connecting the pin to a resistor and a capacitor.		—	I/O	V_{DD}
CE	62	Serial data interface: Connected to the controller. Since DO is an open-drain output, it requires a pull-up resistor.	CE: Chip enable CL: Synchronization clock DI: Transfer data DO: Output data	H	I	GND
CL	63			⌐	I	
DI	64			—	I	
DO	61			—	O	Open
RES	59	Reset input that re-initializes the LSI internal states. During a reset, the display segments are turned off forcibly regardless of the internal display data. All internal key data is reset to low and the key scan operation is disabled. However, serial data can be input during a reset.		L	I	GND
V_{DD}	60	Power supply connection. A supply voltage of between 4.5 and 6.0 V must be provided.		—	—	—
V_{SS}	58	Power supply ground connection. Must be connected to GND.		—	—	—

Serial Data Input

1. When stopped with CL at the low level

CE

CL

DI 0 1 0 0 0 0 1 0 D1 D2 D3 ... D44 D45 D46 0 0 S0 S1 K0 K1 P0 P1 SC 1

B0 B1 B2 B3 A0 A1 A2 A3 |←——— Display data ———→|←—— Control data ——→|

DO

---

0 1 0 0 0 0 1 0 D47 D48 D49 ... D88 D89 D90 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0

B0 B1 B2 B3 A0 A1 A2 A3 |←——— Display data ———→|←—— Fixed data ——→|
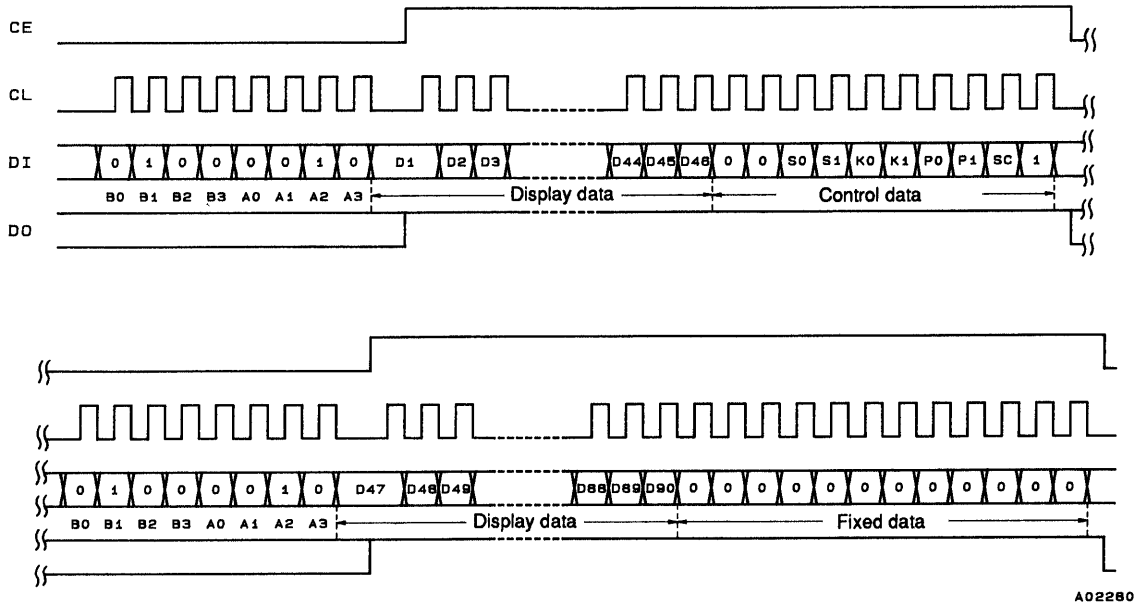
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2. When stopped with CL at the high level

CE

CL

DI 0 1 0 0 0 0 1 0 D1 D2 D3 ... D44 D45 D46 0 0 S0 S1 K0 K1 P0 P1 SC 1

B0 B1 B2 B3 A0 A1 A2 A3 |←——— Display data ———→|←—— Control data ——→|

DO

---

0 1 0 0 0 0 1 0 D47 D48 D49 ... D88 D89 D90 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0

B0 B1 B2 B3 A0 A1 A2 A3 |←——— Display data ———→|←—— Fixed data ——→|

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CCB address ....[42H]
D1 to D90 ....Display data
S0, S1 ....Sleep control data
K0, K1 ....Key scan output/segment output selection data
P0, P1 ....Segment output port/general-purpose output port selection data
SC ....Segment on/off control data

Control Data Functions

1. S0, S1 ....Sleep control data

   This control data switches the LSI between normal mode and sleep mode. It also sets the key scan output standby states for pins KS1 to KS6.

Control data		Mode	Oscillator	Segment outputs Common outputs	Key scan standby mode output pin states					
S0	S1				KS1	KS2	KS3	KS4	KS5	KS6
0	0	Normal	Oscillator	Operation	H	H	H	H	H	H
0	1	Sleep	Stopped	L	L	L	L	L	L	H
1	0	Sleep	Stopped	L	L	L	L	L	H	H
1	1	Sleep	Stopped	L	H	H	H	H	H	H

Note: The KS1/S44 and KS2/S45 output pins are set to the key scan output state.

2. K0, K1 ....Key scan output/segment output selection data

   This control data switches the KS1/S44 and KS2/S45 output pins between the key scan output and segment output functions.

Control data		Output pin states		Maximum number of key inputs
K0	K1	KS1/S44	KS2/S45	
0	0	KS1	KS2	30
0	1	S44	KS2	25
1	X	S44	S45	20

X: don't care

3. P0, P1 ....Segment output port/general-purpose output port selection data

   This control data switches the S1/P1 to S4/P4 output pins between the segment output port and the general-purpose output port functions.

Control data		Output pin states			
P0	P1	S1/P1	S2/P2	S3/P3	S4/P4
0	0	S1	S2	S3	S4
0	1	P1	P2	S3	S4
1	0	P1	P2	P3	S4
1	1	P1	P2	P3	P4

The table below lists the correspondence between the display data and the output pins when the general-purpose output port function is selected.

Output pin	Corresponding display data
S1/P1	D1
S2/P2	D3
S3/P3	D5
S4/P4	D7

For example, if the output pin S4/P4 is set for use as a general-purpose output port, the output pin S4/P4 will output a high level when the display data D7 is 1.

4. SC......................Segment on/off control data

   This control data controls the segment on/off states.

SC	Display state
0	On
1	Off

Display Data and Output Pin Correspondences

Output pin	COM1	COM2
S1/P1	D1	D2
S2/P2	D3	D4
S3/P3	D5	D6
S4/P4	D7	D8
S5	D9	D10
S6	D11	D12
S7	D13	D14
S8	D15	D16
S9	D17	D18
S10	D19	D20
S11	D21	D22
S12	D23	D24
S13	D25	D26
S14	D27	D28
S15	D29	D30
S16	D31	D32
S17	D33	D34
S18	D35	D36
S19	D37	D38
S20	D39	D40
S21	D41	D42
S22	D43	D44
S23	D45	D46
S24	D47	D48
S25	D49	D50
S26	D51	D52
S27	D53	D54
S28	D55	D56
S29	D57	D58
S30	D59	D60
S31	D61	D62
S32	D63	D64
S33	D65	D66
S34	D67	D68
S35	D69	D70
S36	D71	D72
S37	D73	D74
S38	D75	D76
S39	D77	D78
S40	D79	D80
S41	D81	D82
S42	D83	D84
S43	D85	D86
KS1/S44	D87	D88
KS2/S45	D89	D90

For example, the output states of output pin S11 are listed in the table below.

Display data		Output pin state
D21	D22	S11
0	0	Segment off for both COM1 and COM2
0	1	Segment on for COM2
1	0	Segment on for COM1
1	1	Segments on for both COM1 and COM2

Serial Data Output

1. When stopped with CL at the low level

X: don't care

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2. When stopped with CL at the high level

X: don't care
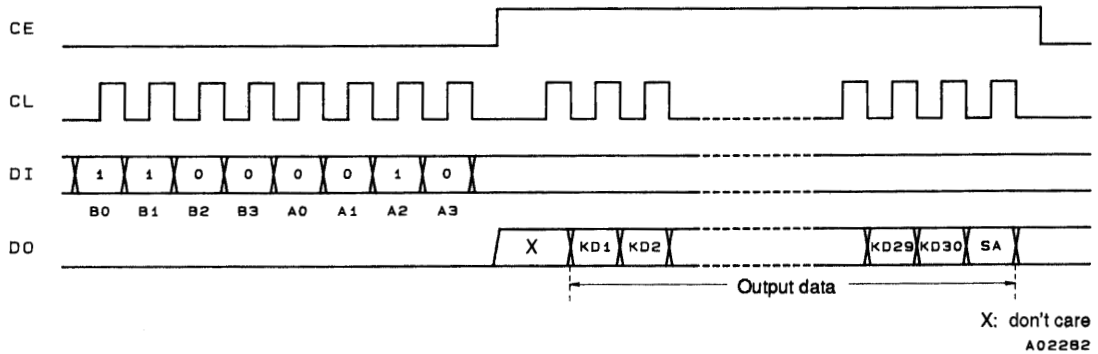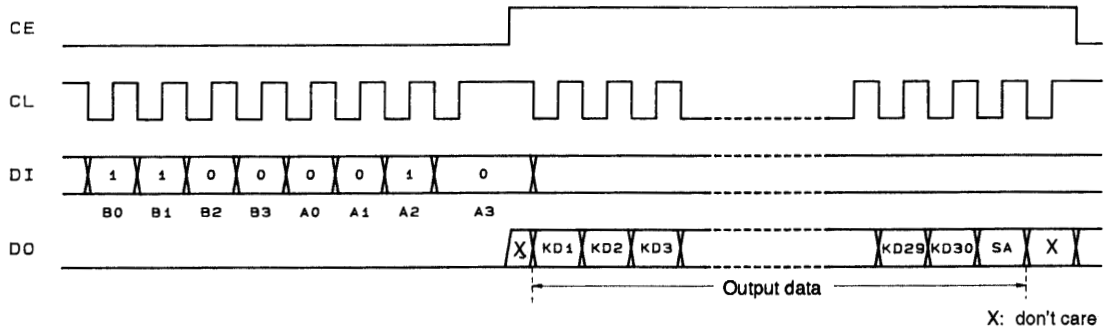
CCB address......................[43H]
KD1 to KD30 ....Key data
SA ....Sleep acknowledge data

Note: If key data is read when DO is high, the key data (KD1 to KD30) and sleep acknowledge data (SA) will be invalid.

Output Data

1. KD1 to KD30.....Key data
    When a key matrix with up to 30 keys is formed using the KS1 to KS6 output pins and the KI1 to KI5 input pins, the key data corresponding to a given key will be 1 if that key is pressed. The table below lists that correspondence.

Item	KI1	KI2	KI3	KI4	KI5
KS1/S44	KD1	KD2	KD3	KD4	KD5
KS2/S45	KD6	KD7	KD8	KD9	KD10
KS3	KD11	KD12	KD13	KD14	KD15
KS4	KD16	KD17	KD18	KD19	KD20
KS5	KD21	KD22	KD23	KD24	KD25
KS6	KD26	KD27	KD28	KD29	KD30

    When the output pins KS1/S44 and KS2/S45 are selected for segment output by the control data K0 and K1, the key data items KD1 to KD10 will be 0.

2. SA ....Sleep acknowledge data
    This output data is set according to the state when the key was pressed. If the LSI was in sleep mode, SA will be 1, and if the LSI was in normal mode, SA will be 0.

Sleep Mode

When S0 or S1 in the control data is set to 1, the oscillator at the OSC pin will stop (it will restart if a key is pressed) and the segment and common outputs will all go to the low level. This reduces the LSI power dissipation. However, the S1/P1 to S4/P4 output pins can be used as general-purpose output ports even in sleep mode if selected for such use by the P0 and P1 control data bits.

Key Scan Operation

1. Key Scan Timing

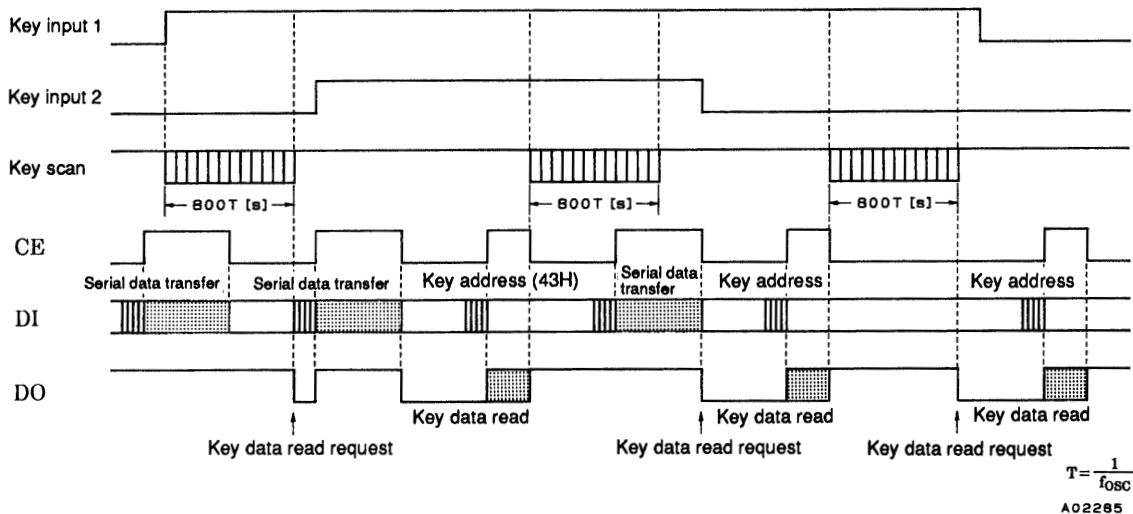   The key scan period is 375T [s]. The key scan is performed twice to reliably determine the key on/off states, and the LSI detects key data agreement. When the key data agrees, the LSI determines that a key has been pressed, and outputs a key read request (by setting DO low) 800T [s] after the key scan started. If a key is pressed again without the key data agreeing, a key scan is performed once more. Thus key on/off operations shorter than 800T [s] cannot be detected.

$$T = \frac{1}{f_{OSC}}$$

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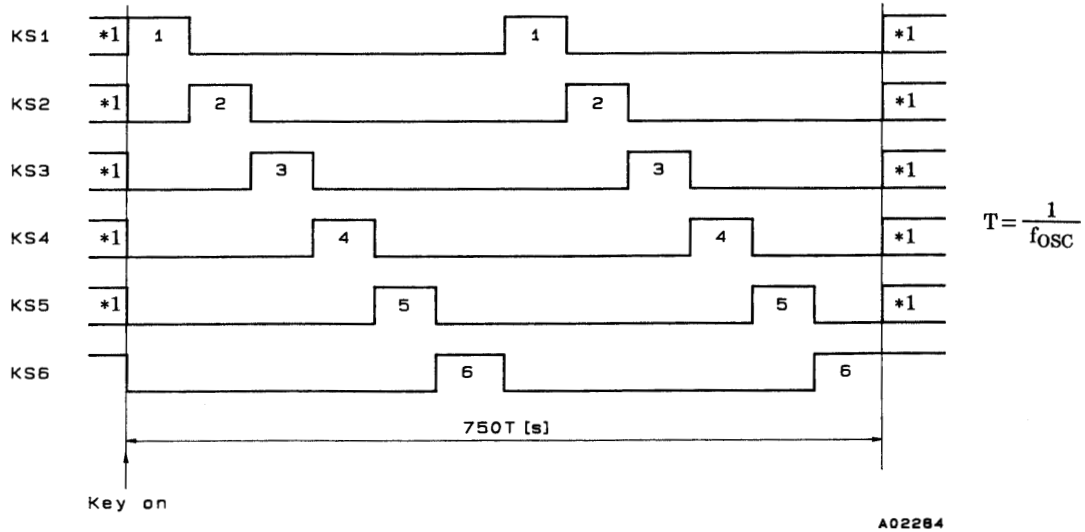
*1 The high or low states of these signals in sleep mode are determined by the S0 and S1 control data bits.

2. Key Scan during Normal Mode
   - The pins KS1 to KS6 are set high.
   - A key scan starts if any key is pressed, and the scan continues until all keys have been released. Multiple key presses can be recognized by determining if multiple key data bits have been set.
   - When a key has been pressed for 800T [s] (where $T = 1/f_{OSC}$) or longer, a key data read request (DO is set to low) is output to the controller. The controller acknowledges this request and reads the key data. However, DO will go high when CE is high during a serial data transfer.
   - After the controller has finished reading the key data, the LSI clears the key data read request (by setting DO high) and performs another key scan. Note that since DO is an open drain output, a pull-up resistor of between 1 and 10 kΩ is required.

$$T = \frac{1}{f_{OSC}}$$
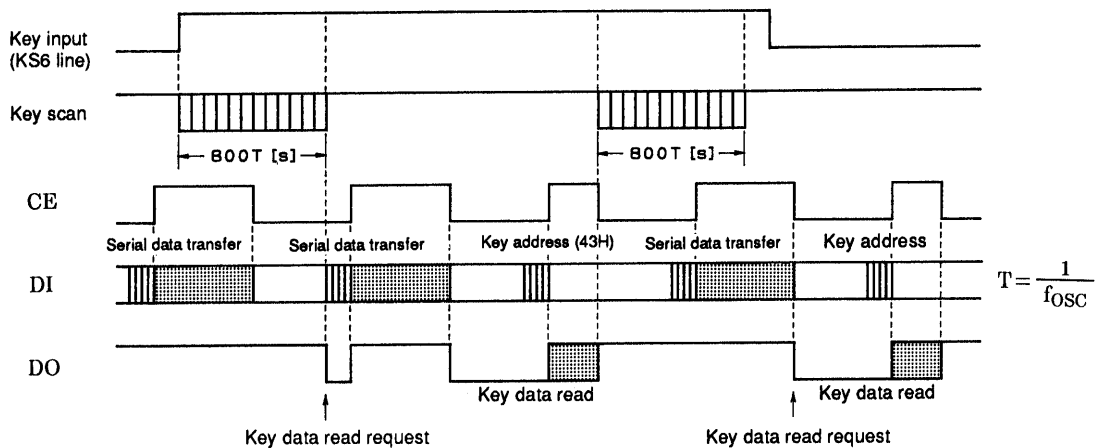
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3. Key Scan during Sleep Mode
    *   The pins KS1 to KS6 are set high or low according to the S0 and S1 control data bits.
        (See the description of the control data function for details.)
    *   If a key for a line corresponding to one of the pins KS1 to KS6 which is high is pressed, the oscillator at the OSC pin starts and a key scan is performed. The key scan continues until all keys have been released. Multiple key presses can be recognized by determining if multiple key data bits have been set.
    *   When a key has been pressed for 800T [s] (where T = 1/f_{OSC}) or longer, a key data read request (DO is set to low) is output to the controller. The controller acknowledges this request and reads the key data. However, DO will go high when CE is high during a serial data transfer.
    *   After the controller has finished reading the key data, the LSI clears the key data read request (by setting DO high) and performs another key scan. Note that since DO is an open drain output, a pull-up resistor of between 1 and 10 kΩ is required.
    *   Key scan example in sleep mode

    Example: Here S0 = 0 and S1 = 1 (This is a sleep in which only KS6 is high.)
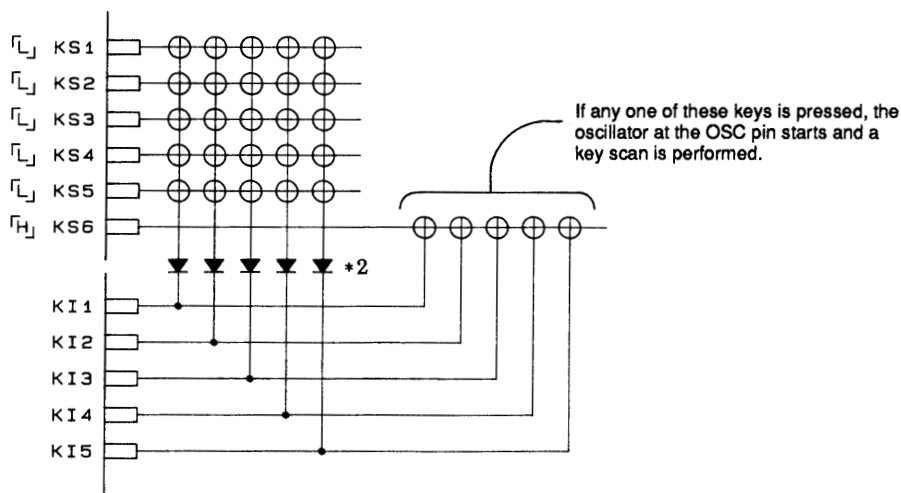
*2: These diodes are required to reliably recognize events in which three or more of the keys on the KS6 line are pressed at the same time.

$$T = \frac{1}{f_{OSC}}$$

Multiple Key Presses

Without the insertion of additional diodes, the LC75852 supports key scan for double key presses in general, triple key presses of keys on the lines for input pins KI1 to KI5, and multiple key presses of keys on the lines for the output pins KS1 to KS6. However, if multiple key presses in excess of these limits occur, the LC75852 may recognize keys that were not pressed as having been pressed. Therefore, series diodes must be connected to each key.

1/2 Duty - 1/2 Bias LCD Drive Scheme

COM1

COM2

$\dfrac{f_{OSC}}{512}$ (Hz)

S1 to S45 outputs for segments on COM1 side being lit

S1 to S45 outputs for segments on COM2 side being lit

S1 to S45 outputs for segments on COM1,COM2 sides being lit

S1 to S45 outputs for segments on COM1,COM2 sides not being lit

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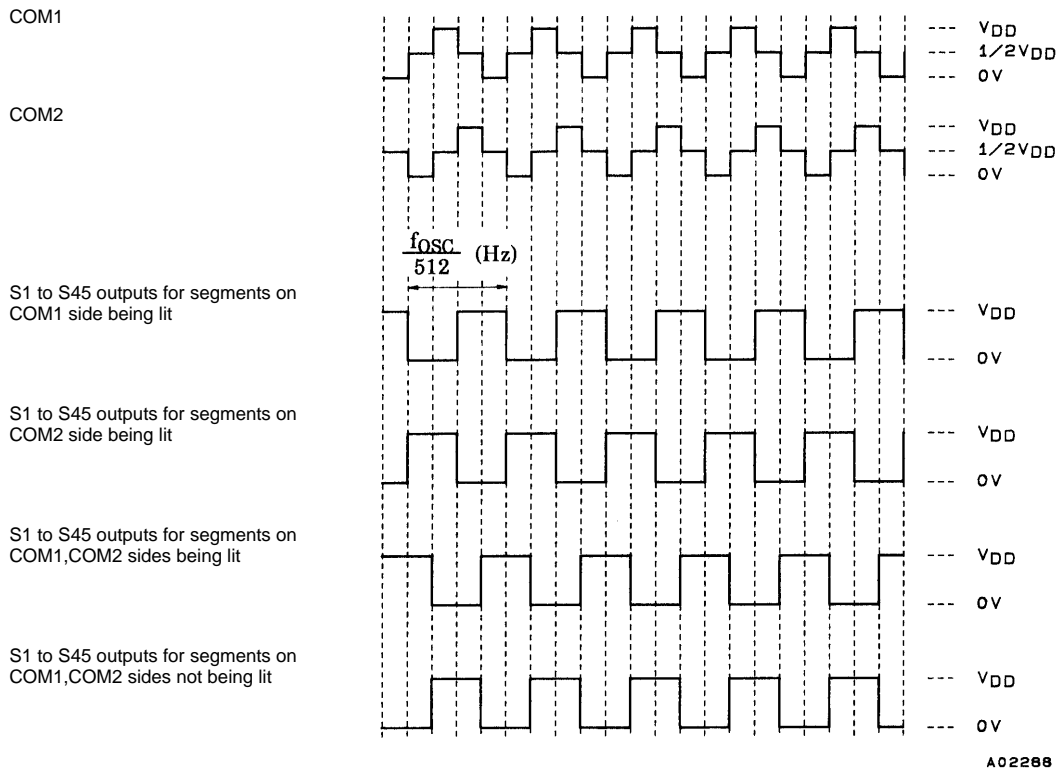
$\overline{\text{RES}}$ and the Display Controller

Since the LSI internal data (D1 to D90 and the control data) is undefined when power is first applied, the output pins S1/P1 to S4/P4, S5 to S43, COM1, COM2, KS1/S44 and KS2/S45 should be held low by setting the $\overline{\text{RES}}$ pin low at the same time as power is applied. Then, meaningless displays at power on can be prevented by transferring data from the controller and setting $\overline{\text{RES}}$ high when that transfer has completed.

A02289

t1 ......Determined by the value of C and R.
t2 ......10 µs min

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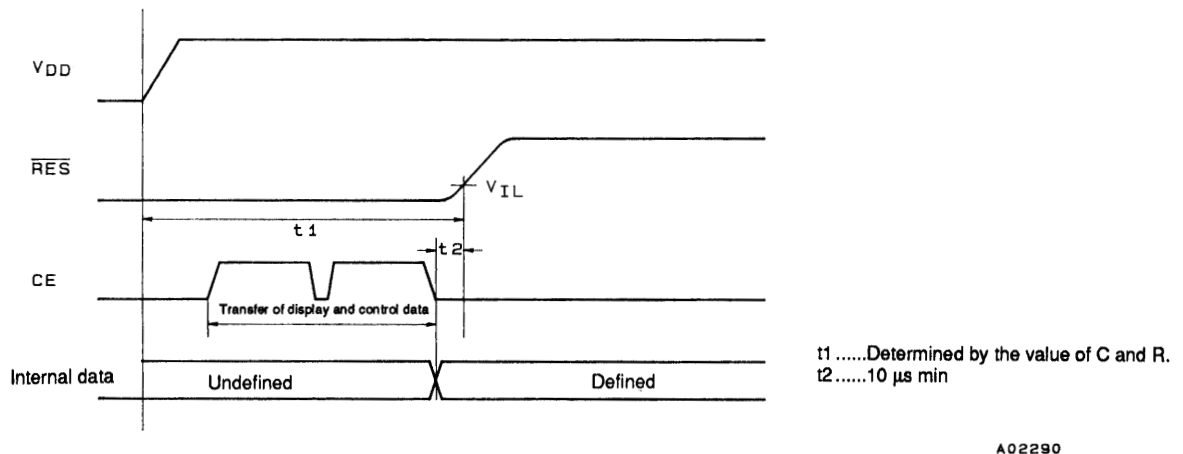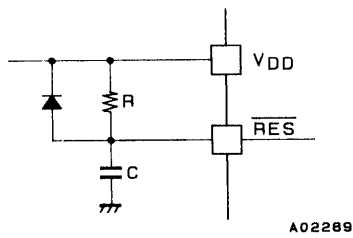
Figure 2

Internal Block States during the Reset Period (when $\overline{\text{RES}}$ is low)

1. CLOCK GENERATOR
   Reset is applied and the basic clock stops. However, the state of the OSC pin (the normal or sleep state) is determined after the control data S0 and S1 has been sent.

2. COMMON DRIVER, SEGMENT DRIVER & LATCH
   Reset is applied and the display is turned off. However, display data can be input to the LATCH.

3. KEY SCAN
   Reset is applied and at the same time as the internal states are set to their initial states, the key scan operation is disabled.

4. KEY BUFFER
   Reset is applied and all the key data is set to the low level.

5. CCB INTERFACE, CONTROL REGISTER, SHIFT REGISTER
   To allow serial data transfers, reset is not applied to these circuits.

Shaded blocks are reset.

A02540
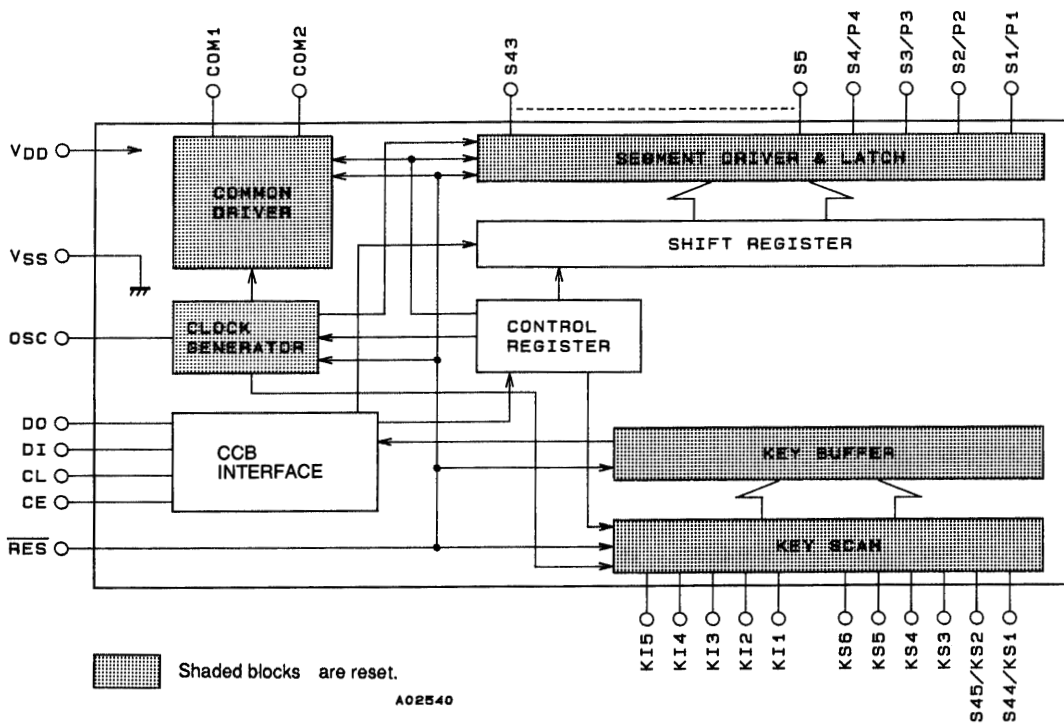
Output Pin States during the Reset Period (when $\overline{\text{RES}}$ is low)

Output pin	State during reset
S1/P1 to S4/P4	L [*3]
S5 to S43	L
COM1, COM2	L
KS1/S44, KS2/S45	L [*3]
KS3 to KS5	X [*4]
KS6	H
DO	H [*5]

X: don't care

Note: 3. These output pins are forcibly set to the segment output mode and held low.
   4. Immediately following power on, these output pins are undefined until the control data S0 and S1 has been sent.
   5. Since this output pin is an open-drain output, a pull-up resistor of between 1 and 10 kΩ is required. This pin is held high during the reset period even if key data is read.

Sample Application Circuit

OSC

+5V

V_{DD}

RES

V_{SS}

CE

CL

DI

DO

From the controller

To the controller

To the controller power supply

*

(P1)
(P2)
(P3)
(P4)

(general-purpose output port)
Used for functions such as backlight control

COM1
COM2

P1/S1
P2/S2
P3/S3
P4/S4
S5

S43

S44
S45

S44/KS6
S45/KS1

LCD panel (up to 90 segments)

(S44)
(S45)

KI5 KI4 KI3 KI2 KI1   KS6 KS5 KS4 KS3 KS2 KS1

Key matrix (up to 30 keys)
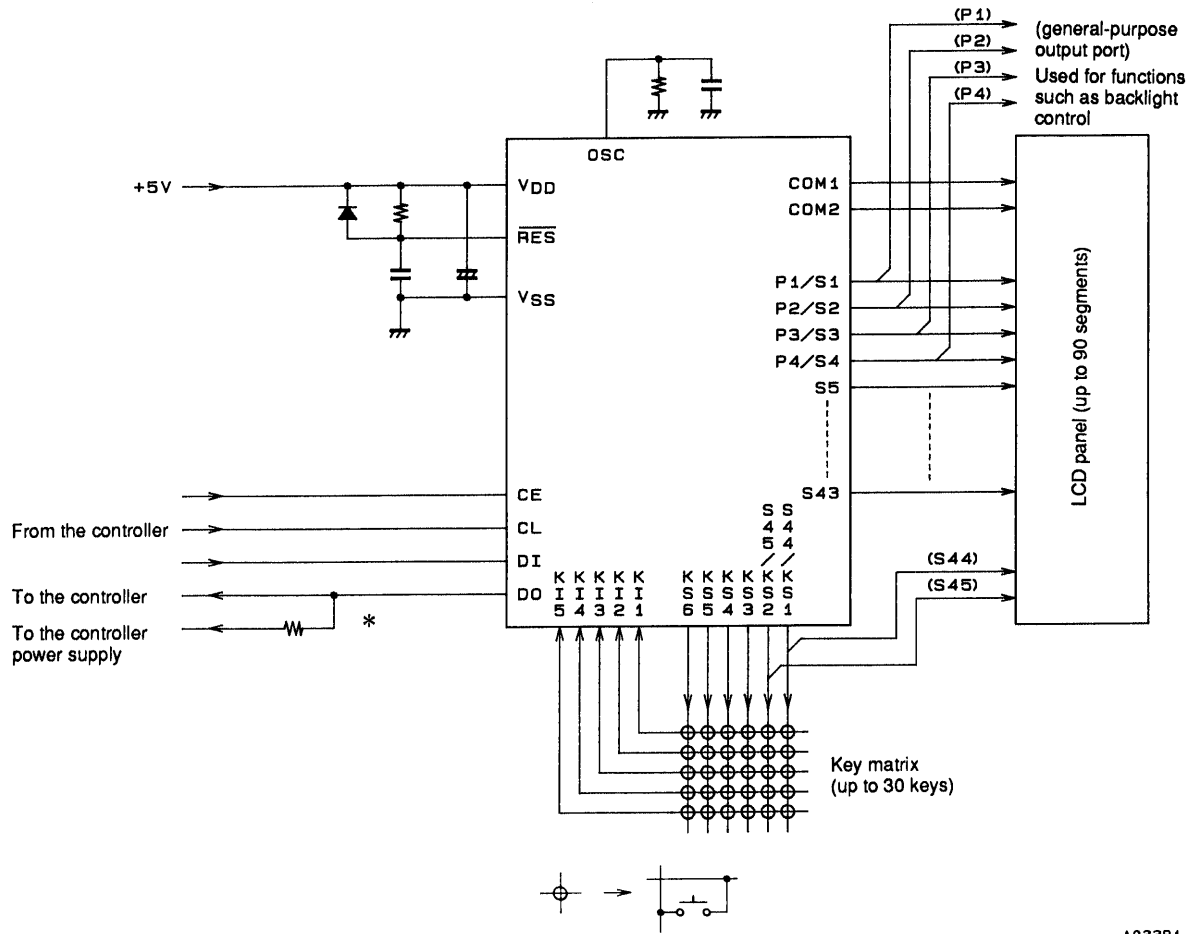
A02291

Note: * Since DO is an open-drain output, a pull-up resistor is required. Select a value (between 1 and 10 kΩ) that is appropriate for the capacitance of the external wiring so that the waveforms are not distorted.

Notes on Controller Display Data Transfer

The LC75852 transfers the display data (D1 to D90) in two operations. To assure visual display quality, all the display data should be sent within a 30 ms or shorter period.

Notes on Controller Key Data Read Techniques

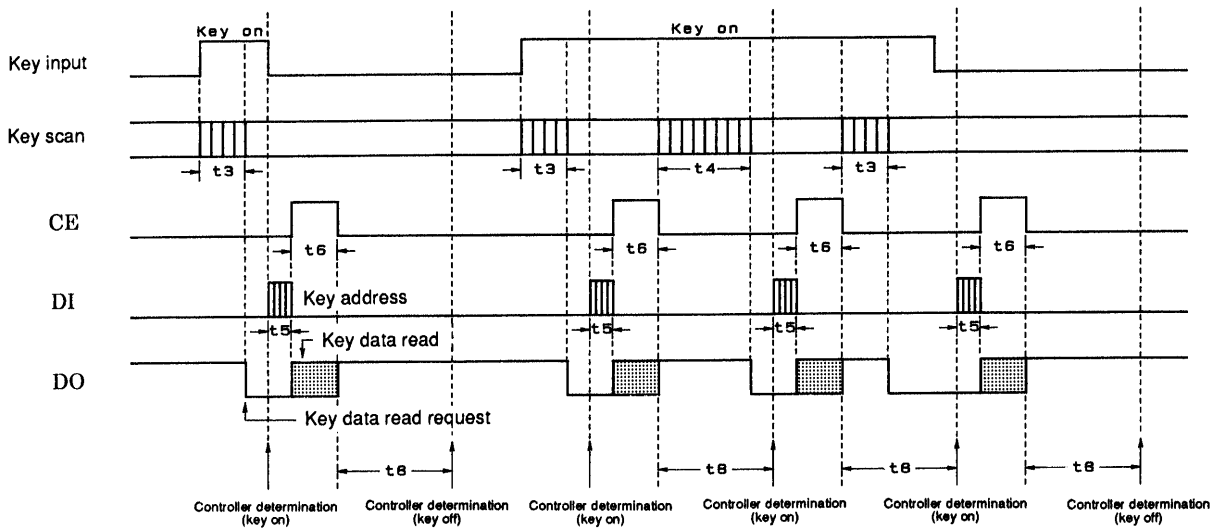1. Controller key data reading under timer control
   • Flowchart
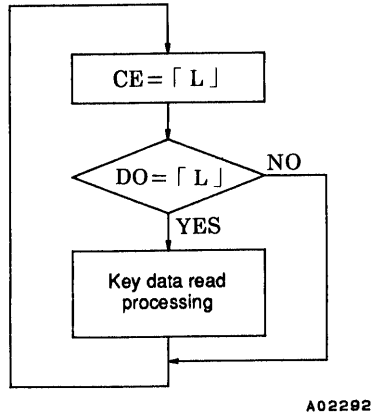
• Timing Chart
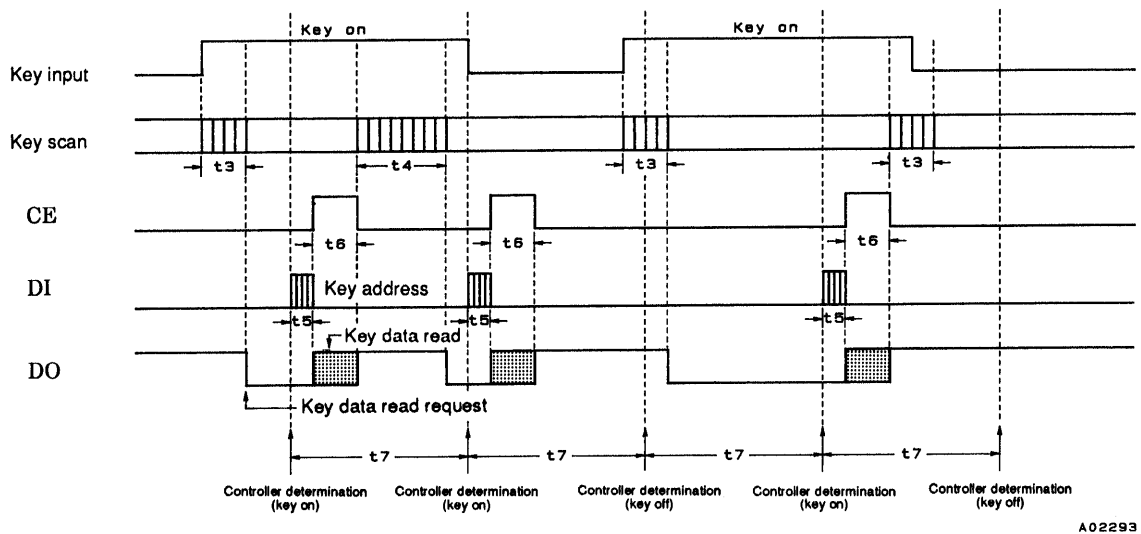
t3 ....Key scan execution time (800T [s]) when the key scan data for two key scans agrees
t4 ....Key scan execution time (1600T [s]) when the key scan data for two key scans does not agree and a key scan is executed again
t5 ....Key address (43H) transfer time
t6 ....Key data read time

$$T = \frac{1}{f_{osc}}$$

• Description
   When determining key on/off and reading key data, the controller must confirm the state of DO output when CE is low for each period t7. When DO is low, the controller recognizes that a key has been pressed and reads the key data.
   During this operation t7 must obey the following condition:

   $t7 > t5 + t6 + t4$

   <u>If key data is read when DO is high, the key data (KD1 to KD30) and the sleep acknowledge data (SA) will be invalid.</u>

2. Controller key data reading under interrupt control
   • Flowchart


```
        ┌──────────────────────┐
        │      CE = 「 L 」       │
        └──────────────────────┘
                  │
            ◇ DO = 「 L 」 ◇──── NO
                  │ YES
        ┌──────────────────────┐
        │   Key data read      │
        │     processing       │
        └──────────────────────┘
                  │
        ┌──────────────────────┐
        │    Wait for at       │
        │    least t8          │
        └──────────────────────┘
                  │
        ┌──────────────────────┐
        │      CE = 「 L 」       │
        └──────────────────────┘
                  │
  NO ────◇ DO = 「 H 」 ◇
                  │ YES
        ┌──────────────────────┐
        │      Key off         │
        └──────────────────────┘
```
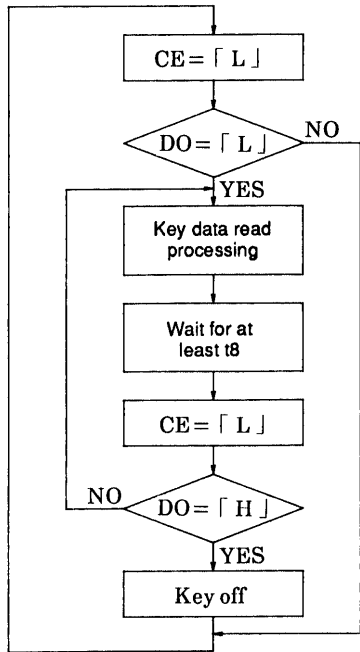
A02294

   • Timing Chart

A02295

t3 ....Key scan execution time (800T [s]) when the key scan data for two key scans agrees

t4 ....Key scan execution time (1600T [s]) when the key scan data for two key scans does not agree and a key scan is executed again

t5 ....Key address (43H) transfer time

t6 ....Key data read time

$$T = \frac{1}{f_{osc}}$$

• Description

When determining key on/off and reading key data, the controller must confirm the state of DO output when CE is low. When DO is low, the controller recognizes that a key has been pressed and reads the key data. After the time t8, the next key on/off determination and reading key data must be confirmed by the state of DO output when CE is low. During this operation t8 must obey the following condition :

$t8 > t4$

If key data is read when DO is high, the key data (KD1 to KD30) and the sleep acknowledge data (SA) will be invalid.